



ESDA6V1-5SC6

ASD™

TRANSIL™ ARRAY FOR ESD PROTECTION

MAIN APPLICATIONS

Where transient overvoltage protection in ESD sensitive equipment is required, such as:

- Computers
- Printers
- Communication systems
- Cellular phone handsets and accessories
- Other telephone set
- Set top boxes

FEATURES

- 5 Unidirectional Transil™ Functions
- Low leakage current: I_R max. < 1µA
- Breakdown voltage: V_{BR} = 6.1V min.

DESCRIPTION

The ESDA6V1-5SC6 is a 5-bit wide monolithic suppressor which is designed to protect against ESD components connected to data and transmission lines.

BENEFITS

- High integration
- Suitable for high density boards

COMPLIES WITH THE FOLLOWING STANDARDS:

| | | Test kV | Max. current |
|--|---------|---------|--------------|
| IEC61000-4-2 level 4 | Air | 15 | - |
| | Contact | 8 | 30A |
| MIL STD 883C-Method 3015-7 class3 (Human Body Model) | Contact | > 4 | > 2.67A |

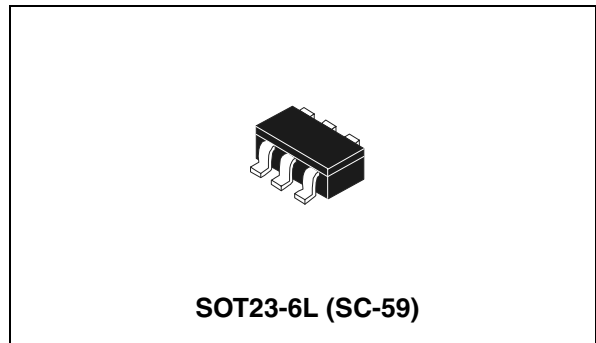


Table 1: Order Code

| Part Number | Marking |
|--------------|---------|
| ESDA6V1-5SC6 | EC62 |

Figure 1: Functional Diagram

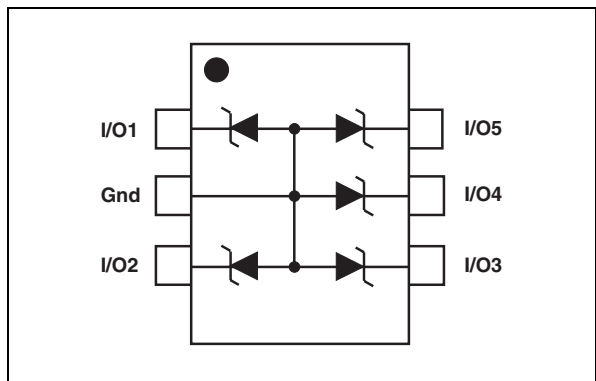
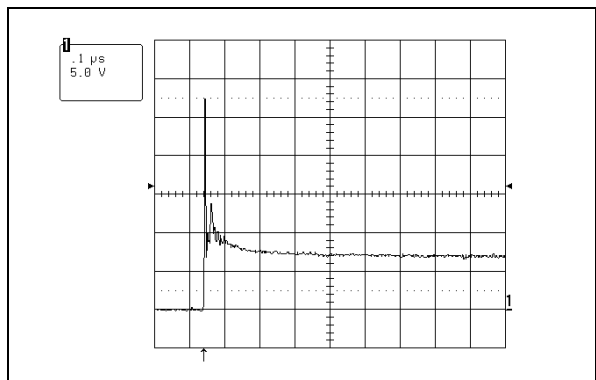


Figure 2: ESD response to IEC61000-4-2 (air discharge 16kV, positive surge)



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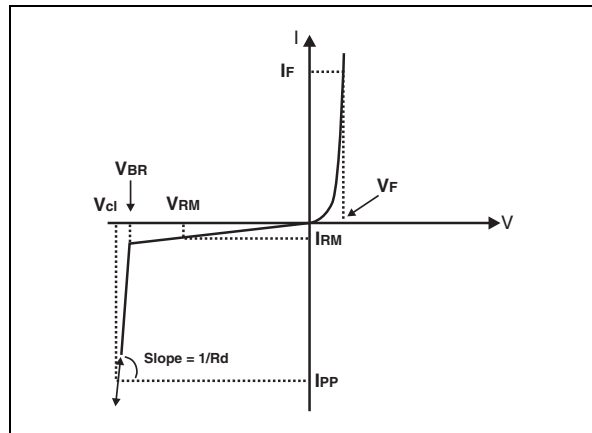
Table 2: Absolute Maximum Ratings ($T_{amb} = 25^{\circ}\text{C}$)

| Symbol | Parameter | Value | Unit |
|-----------|--|--------------------------------|--------------------|
| V_{PP} | ESD discharge | MIL STD 883E - Method 3015-7 | 25 |
| | | IEC61000-4-2 air discharge | 20 |
| | | IEC61000-4-2 contact discharge | 15 |
| P_{PP} | Peak pulse power (8/20 μs) | 100 | W |
| T_j | Junction temperature | 150 | $^{\circ}\text{C}$ |
| T_{stg} | Storage temperature range | -55 to +150 | $^{\circ}\text{C}$ |
| T_L | Maximum lead temperature for soldering during 10 s at 5mm for case | 260 | $^{\circ}\text{C}$ |
| T_{op} | Operating temperature range (note 1) | -40 to +125 | $^{\circ}\text{C}$ |

Note 1: The evolution of the operating parameters versus temperature is given by curves and αT parameter.

Table 3: Electrical Characteristics ($T_{amb} = 25^{\circ}\text{C}$)

| Symbol | Parameter |
|------------|---------------------------------|
| V_{RM} | Stand-off voltage |
| V_{BR} | Breakdown voltage |
| V_{CL} | Clamping voltage |
| I_{RM} | Leakage current |
| I_{PP} | Peak pulse current |
| αT | Voltage temperature coefficient |
| V_F | Forward voltage drop |
| C | Capacitance |
| R_d | Dynamic resistance |



| Type | V_{BR} @ | | I_R | I_{RM} @ V_{RM} | | R_d | αT | C | V_F @ I_F | |
|--------------|------------|------|-------|---------------------|---|------------------|----------------------------|-----|---------------|-----|
| | min. | max. | | max. | | | | | max. | |
| | V | V | mA | μA | V | $\text{m}\Omega$ | $10^{-4}/^{\circ}\text{C}$ | pF | V | mA |
| ESDA6V1-5SC6 | 6.1 | 7.2 | 1 | 1 | 3 | 590 | 6 | 50 | 1.25 | 200 |

Note 2: Square pulse, $I_{PP} = 15\text{A}$, $t_p = 2.5\mu\text{s}$.

Note 3: $\Delta V_{BR} = \alpha T * (T_{amb} - 25^{\circ}\text{C}) * V_{BR}(25^{\circ}\text{C})$.

Figure 3: Peak power dissipation versus initial junction temperature

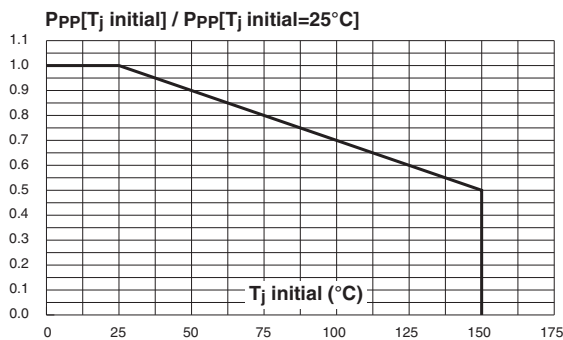
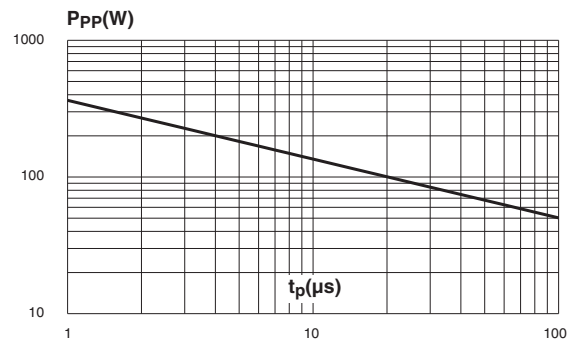


Figure 4: Peak power versus exponential pulse duration ($T_j \text{ initial} = 25^{\circ}\text{C}$)



**Figure 5: Clamping voltage versus peak pulse current (T_j initial = 25 °C).
Rectangular waveform ($t_p = 2.5 \mu s$)**

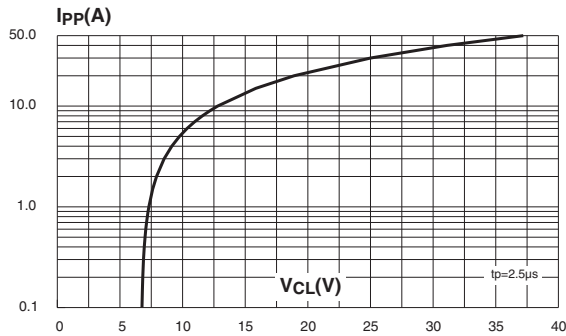


Figure 6: Capacitance versus reverse applied voltage (typical values)

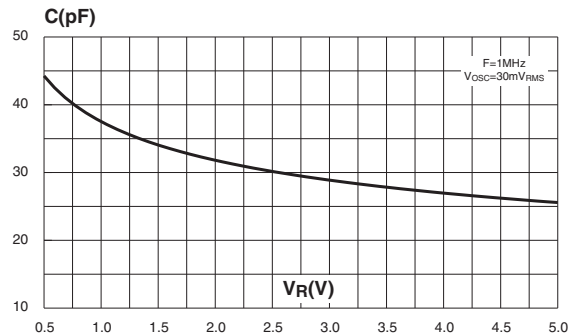


Figure 7: Relative variation of leakage current versus junction temperature (typical values)

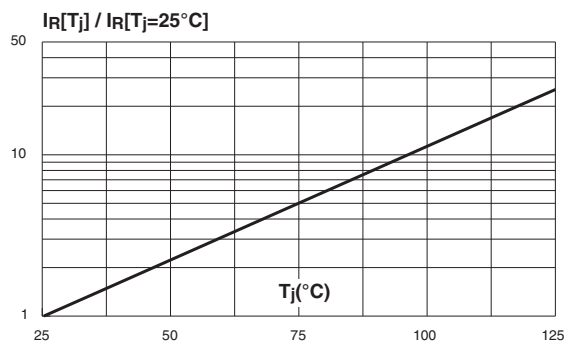


Figure 8: Peak forward voltage drop versus peak forward current (typical values)

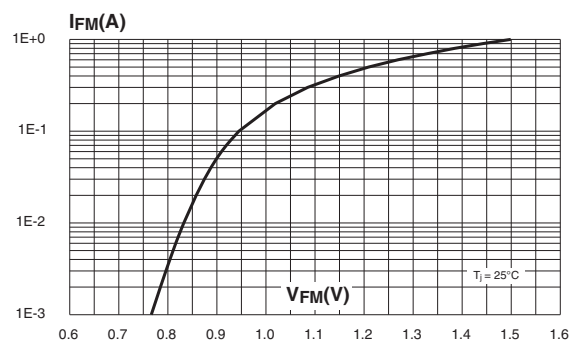


Figure 9: Ordering information scheme

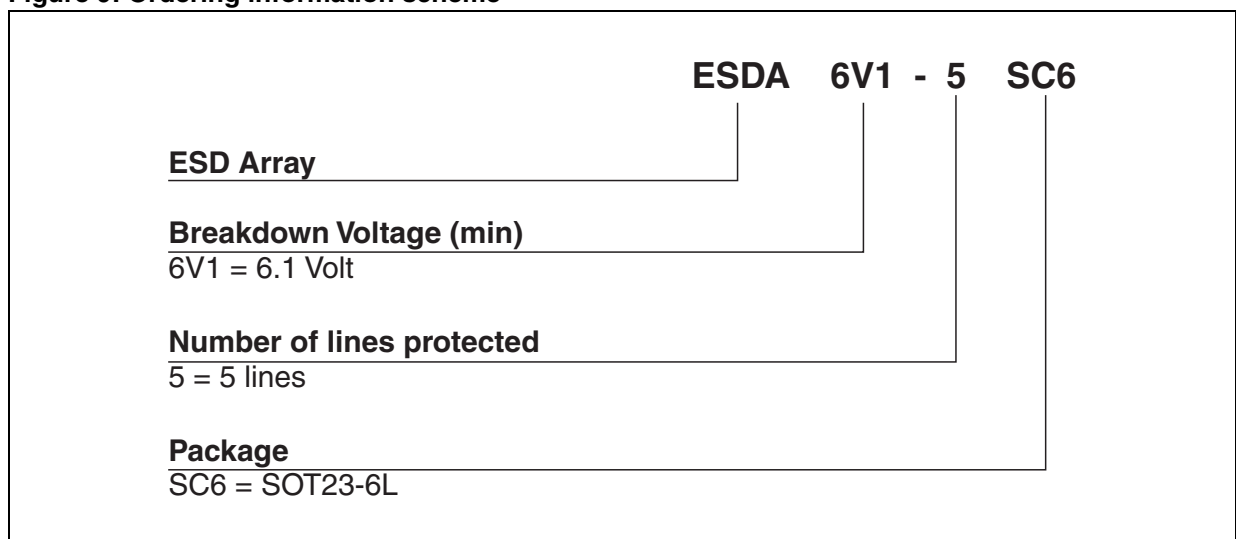


Figure 10: SOT23-6L Package Mechanical Data

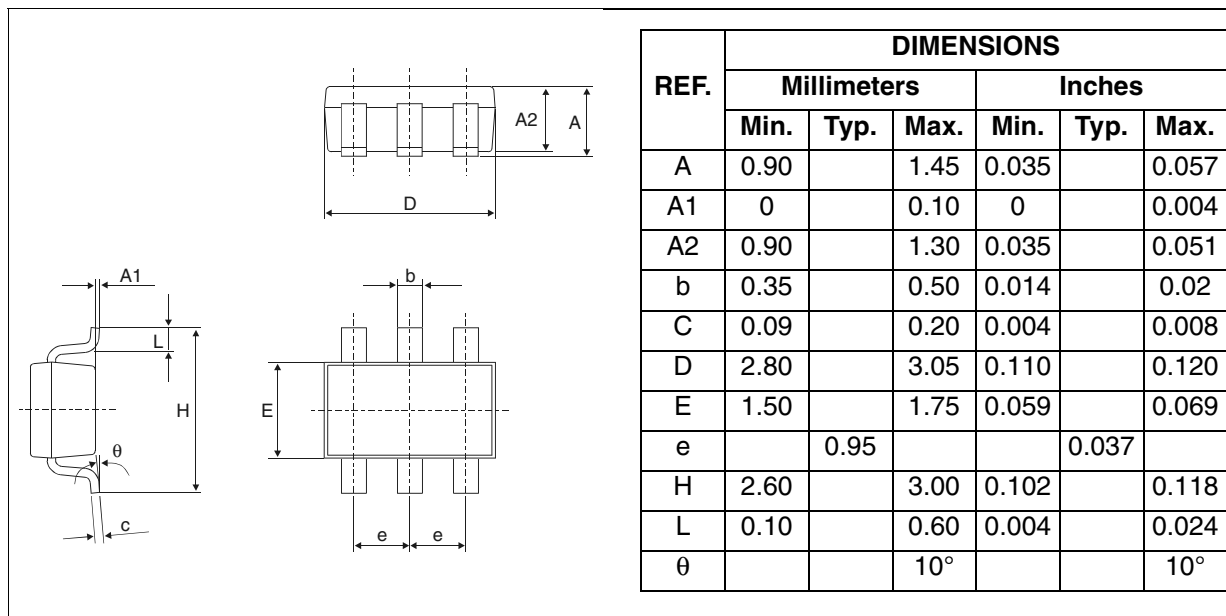


Figure 11: Foot Print Dimensions (in millimeters)

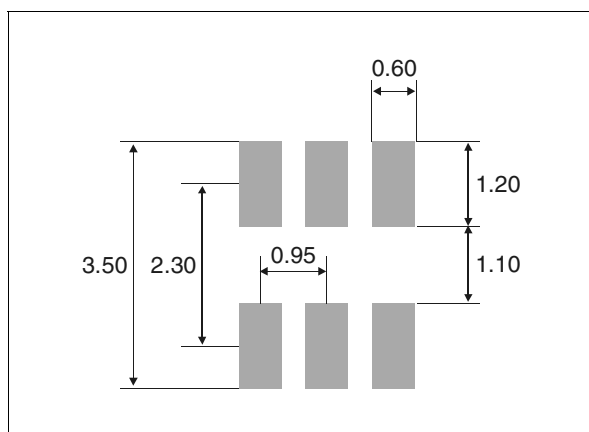


Table 4: Ordering Information

| Part Number | Marking | Package | Weight | Base qty | Delivery mode |
|--------------|---------|----------|---------|----------|---------------|
| ESDA6V1-5SC6 | EC62 | SOT23-6L | 16.7 mg | 3000 | Tape & reel |

Table 5: Revision History

| Date | Revision | Description of Changes |
|------------|----------|--|
| Feb-2002 | 2B | Last update. |
| 4-Nov-2004 | 3 | SOT23-6L package dimensions change for reference “D” from 3.0 millimeters (0.118 inches) to 3.05 millimeters (0.120 inches). |

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